



# MEDIUM SENSITIVITY MICROPOWER OMNIPLOAR HALL-EFFECT SWITCH

### **Description**

The AH1807 is a medium sensitivity micropower Omnipolar Hall Effect switch IC. It is designed for battery powered consumer products, home appliances, and industrial equipment such as smart meter magnetic tamper detect. Based on two Hall Effect plates and a chopper stabilized architecture, the AH1807 provides a reliable solution over the whole operating range. To support battery and low power applications, the design has been optimized to operate over the supply range of 2.5V to 5.5V and consumes only  $24\mu W$  with a supply of 3V.

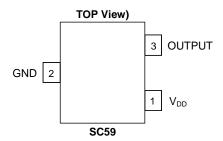
The single open drain output can be switched on with either a North or South pole of sufficient strength. When the magnetic flux density (B) perpendicular to the package is larger than operate point (Bop), the output is switched on (pulled low). The output is turned off when B becomes lower than the release point (Brp). The output will remain off when there is no magnetic field.

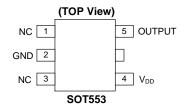
The AH1807 is available in SC59, SOT553 and SIP-3L.

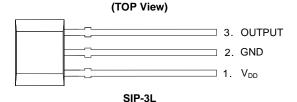
#### **Features**

- Omnipolar (North or South pole) Operation
- Medium Sensitivity
- Single Open Drain Output
- Micropower Operation
- 2.5V to 5.5V Operating Range
- Chopper Stabilized Design Provides:
  - Superior Temperature Stability
  - Minimal Switch Point Drift
  - Enhanced Immunity to Stress
- Good RF Noise immunity
- -40°C to +125°C Operating Temperature
- High ESD
- Small Low Profile SOT553 and Industry Standard SC59 and SIP-3L Packages
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Pin Assignments**







#### **Applications**

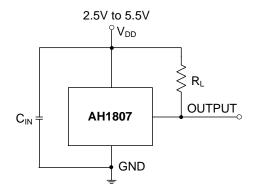
- Smart E-Meters
- Tamper Protection Switch
- Door, Lids and Tray Position Switch
- Proximity and Position Switches
- Level Detects
- On/Off Switch Digital Contact-Less Switch in Industrial and Consumer Products

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



## **Typical Applications Circuit**



Note:

4.  $C_{IN}$  is for power stabilization and to strengthen the noise immunity, the recommended capacitance is 10nF to 100nF.  $R_L$  is the pull-up resistor, the recommended resistance is  $10k\Omega$  to  $100k\Omega$ .

### **Pin Descriptions**

Package: SC59 and SIP-3L

Pin Number	Pin Name	Function
1	$V_{DD}$	Power Supply Input
2	GND	Ground
3	OUTPUT	Output Pin

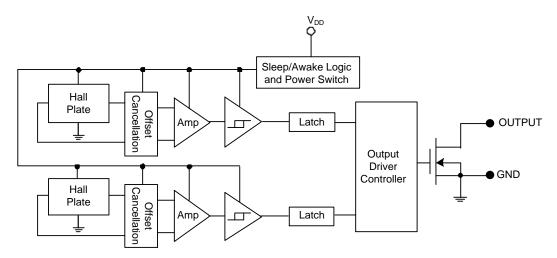
Package: SOT553

Pin Number	Pin Name	Function			
1	NC	No Connection (Note 5)			
2	GND	Ground			
3	NC	No Connection (Note 5)			
4	$V_{DD}$	Power Supply Input			
5	OUTPUT	Output			

Note:

5. NC is "No Connection" pin and is not connected internally. This pin can be left open or tied to ground.

# **Functional Block Diagram**





#### Absolute Maximum Ratings (Note 6) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Characteristics		Values	Unit	
$V_{DD}$	Supply Voltage (Note 7)		7	V	
Vout	Output Pin Voltage (Note 7)		7	V	
V <sub>DD REV</sub>	Reverse Supply Voltage		-0.3	V	
$V_{\text{OUT\_REV}}$	Reverse Output Pin Voltage	-0.3	V		
IOUTPUT	Output Current (source and sink)	2.5	mA		
В	Magnetic Flux Density		Unlimited		
D-	Package Power Dissipation	SC59 and SOT553	230	mW	
P <sub>D</sub>	Fackage Fower Dissipation	SIP-3L	230		
Ts	Storage Temperature Range	-65 to +150	°C		
TJ	Maximum Junction Temperature	150	°C		
ESD HBM	Human Body Model ESD Capability	6	kV		

Notes:

- 6. Stresses greater than the 'Absolute Maximum Ratings' specified above may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.
- 7. The absolute maximum V<sub>DD</sub> of 7V is a transient stress rating and is not meant as a functional operating condition. It is not recommended to operate the device at the absolute maximum rated conditions for any period of time.

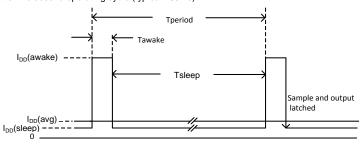
### Recommended Operating Conditions (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Characteristic	Conditions	Rating	Unit
$V_{DD}$	Supply Voltage	Operating	2.5 to 5.5	V
$V_{OUT\_MAX}$	Maximum output pin voltage	Operating	5.5	V
T <sub>A</sub>	Operating Temperature Range	Operating	-40 to +125	°C

### Electrical Characteristics (@T<sub>A</sub> = +25°C, V<sub>DD</sub> = 3V, unless otherwise specified.)

Symbol	Characteristic	Conditions	Min	Тур	Max	Unit
Vout_on	Output On Voltage (VoL)	I <sub>OUT</sub> = 1mA	_	0.1	0.3	V
I <sub>OFF</sub>	Output Leakage Current	V <sub>OUT</sub> = 5.5V, Output off	_	< 0.1	1	μΑ
I (avvalva)		During 'awake' period, T <sub>A</sub> = +25°C, V <sub>DD</sub> = 3V	_	3	6	mA
I <sub>DD</sub> (awake)		During 'awake' period, T <sub>A</sub> = -40 to +125°C, V <sub>DD</sub> = 2.5V to 5.5V	_	_	12	mA
I <sub>DD</sub> (sleep)	Supply Current	During 'sleep' period, T <sub>A</sub> = +25°C, V <sub>DD</sub> = 3V	_	5	10	μΑ
I <sub>DD</sub> (sleep)		During 'sleep' period, $T_A = -40 \text{ to } +125^{\circ}\text{C}, V_{DD} = 2.5\text{V to } 5.5\text{V}$	_	_	28	μΑ
J. (0)(0)	Average Supply Current	$T_A = 25^{\circ}C, V_{DD} = 3V$	_	8	16	μΑ
I <sub>DD</sub> (avg)	Average Supply Current	$T_A = -40 \text{ to } +125^{\circ}\text{C}, V_{DD} = 2.5\text{V to } 5.5\text{V}$	_	-	40	μΑ
Tawake	Awake Time	(Note 8)	_	75	125	μs
Tperiod	Period	(Note 8)	_	75	125	ms
D.C.	Duty Cycle		_	0.1	_	%

Note: 8. When power is initially turned on, the operating V<sub>DD</sub> must be within its correct operating range (2.5V to 5.5V) to guaranteed the output sampling. The output state is valid after the second operating cycle (typical 150ms).





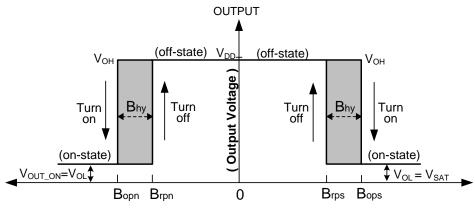
### Magnetic Characteristics (Notes 9 & 10) (@ $T_A = +25$ °C, $V_{DD} = 2.5$ V to 5.5V, unless otherwise specified.)

(1mT=10 Gauss)

Symbol	Characteristics	Test Condition	Min	Тур	Max	Unit
		T <sub>A</sub> = +25°C	60	80	105	
Bops (south pole to part marking side)	Operation Daint	$T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}$	50	80	115	
Dona (north note to nort marking side)	Operation Point	T <sub>A</sub> = +25°C	-105	-80	-60	
Bopn (north pole to part marking side)		$T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}$	-115	-80	-50	
Drng (south note to part marking side)		T <sub>A</sub> = +25°C	50	65	90	Gauss
Brps (south pole to part marking side)	Dalasas Dalas	$T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}$	40	65	100	Gauss
Draw (north note to nort marking side)	Release Point	T <sub>A</sub> = +25°C	-90	-65	-50	
Brpn (north pole to part marking side)		$T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}$	-100	-65	-40	
Phy (IPanyl IProvi)	Hysteresis (Note 11)	T <sub>A</sub> = +25°C	10	15	20	
Bhy ( Bopx - Brpx )	Trysteresis (Note 11)	$T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}$	5	15	_	

Notes:

- 9. Typical data is at  $T_A = +25$ °C,  $V_{DD} = 3V$ .
- 10. Parameters values over operating temperature range are not tested in production, they are guaranteed by design, process control and characterization. The magnetic characteristics may vary with supply voltage, operating temperature and after soldering.11. Maximum and minimum hysteresis is guaranteed by design and characterization.

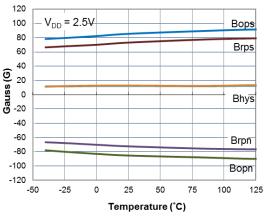


(Magnetic Flux Density B)

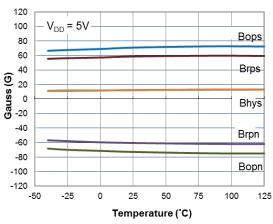
Downloaded from Arrow.com.



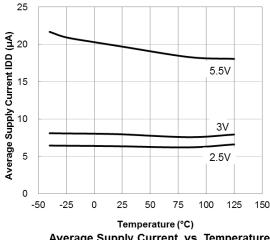
# **Typical Operating Characteristics**



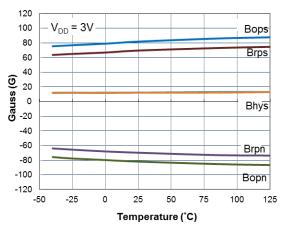
**Switch Points vs Temperature** 



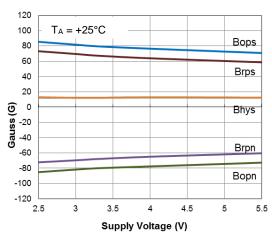
Switch Points vs Temperature



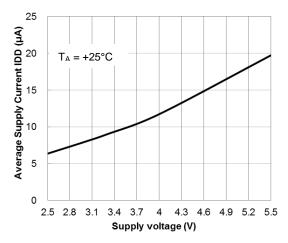
Average Supply Current vs. Temperature



**Switch Points vs Temperature** 



Switch Points vs Supply Voltage



Average Supply Current vs. Supply Voltage

May 2015



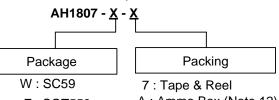
#### **Thermal Performance Characteristics**

#### (1) Package type: SC59, SOT553 and SIP-3L

T <sub>A</sub> (°C)	25	50	60	70	80	85	90	100	110	120	130	140	150
P <sub>D</sub> (mW)	230	184	166	147	129	120	110	92	74	55	37	18	0



### **Ordering Information**



A: Ammo Box (Note 12) Z: SOT553 B: Bulk (Note 13) P:SIP-3L

	Bookogo			Bulk	7" Tape an	7" Tape and Reel Amı		Ammo Box	
Device	Package Code	Packaging	Quantity	Part Number Suffix	Quantity	Part Number Suffix	Quantity	Part Number Suffix	
AH1807-W-7	W	SC59	NA	NA	3,000/Tape & Reel	-7	NA	NA	
AH1807-Z-7	Z	SOT553	NA	NA	3,000/Tape & Reel	-7	NA	NA	
AH1807-P-B	Р	SIP-3L	1000	-B	NA	NA	NA	NA	
AH1807-P-A	Р	SIP-3L	NA	NA	NA	NA	4,000/Box	-A	

Notes: 12. Ammo Box is for SIP-3L Spread Lead.

13. Bulk is for SIP-3L Straight Lead.



#### **Marking Information**

#### (1) Package Type: SC59



XX Y W X

XX: Identification code

Y: Year 0 to 9

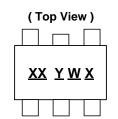
 $\underline{W}$ : Week: A to Z: 1 to 26 week; a to z: 27 to 52 week; z represents

52 and 53 week

X: Internal Code

Part Number	Package	Identification Code	
AH1807	SC59	H7	

#### (2) Package Type: SOT553



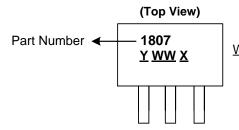
 $\frac{XX}{Y}: \text{Identification Code} \\ \underline{Y}: \text{Year}: 0 \text{ to } 9$ 

W: Week: A to Z: 1~26 week; a to z: 27~52 week; z represents 52 and 53 week

X: Internal code

Part Number	Package	Identification Code	
AH1807	SOT553	J7	

#### (3) Package Type: SIP-3L



Y: Year: 0~9

WW: Week: 01~52, "52" represents

52 and 53 week

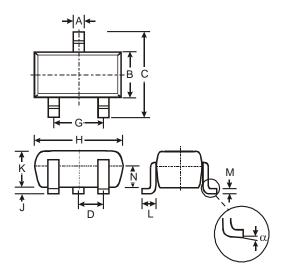
X: Internal Code



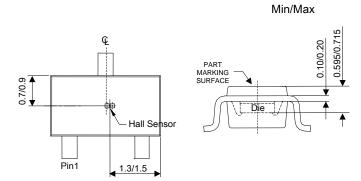
### Package Outline Dimensions (All dimensions in mm.)

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

#### (1) Package Type: SC59



	SC59							
Dim	Min	Max	Тур					
Α	0.35	0.50	0.38					
В	1.50	1.70	1.60					
С	2.70	3.00	2.80					
D	-	-	0.95					
G	-	-	1.90					
Н	2.90	3.10	3.00					
J	0.013	0.10	0.05					
K	1.00	1.30	1.10					
L	0.35	0.55	0.40					
M	0.10	0.20	0.15					
N	0.70	0.80	0.75					
α	0°	8°	-					
All	Dimens	ions in	mm					



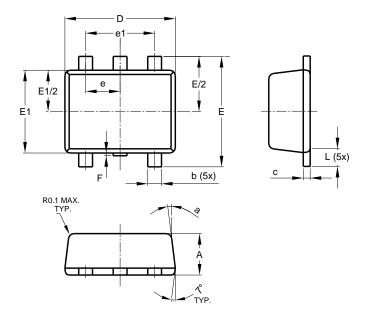
**Sensor Location** 



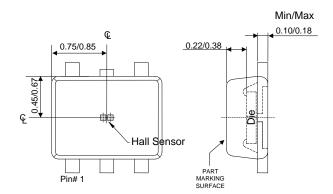
### Package Outline Dimensions (All dimensions in mm.)

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

#### (2) Package Type: SOT553



	SOT553						
Dim	Min	Max	Тур				
Α	0.55	0.62	0.60				
b	0.15	0.30	0.20				
С	0.10	0.18	0.15				
D	1.50	1.70	1.60				
Е	1.55	1.70	1.60				
E1	1.10	1.25	1.20				
е	(	0.50 BS0	)				
e1	·	1.00 BS0	)				
F	0.00	0.10	_				
L	0.10	0.30	0.20				
а	6°	8°	7°				
All Dimensions in mm							



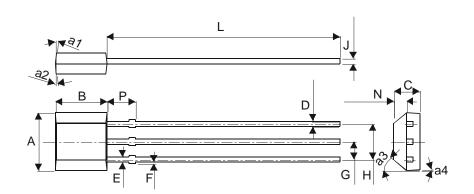
**Sensor Location** 



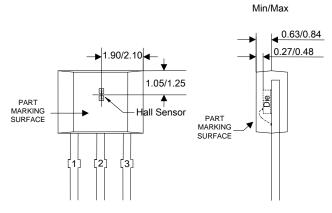
## Package Outline Dimensions (cont.) (All dimensions in mm.)

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

#### (3) Package Type: SIP-3L for Bulk Pack



SIP-3 for Bulk Pack		
Dim	Min	Max
Α	3.9	4.3
a1	5° Typ	
a2	5° Typ	
а3	45° Typ	
a4	3° Тур	
В	2.8	3.2
С	1.40	1.60
D	0.33	0.432
Е	0.40	0.508
F	0	0.2
G	1.24	1.30
Н	2.51	2.57
J	0.35	0.43
L	14.0	15.0
N	0.63	0.84
Р	1.55	-
All Dimensions in mm		



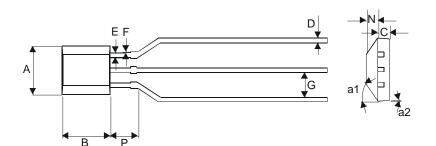
**Sensor location** 



## Package Outline Dimensions (cont.) (All dimensions in mm.)

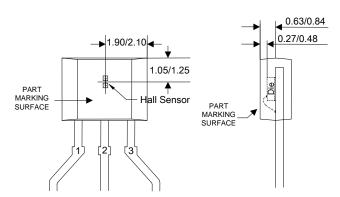
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

#### (4) Package Type: SIP-3L for Ammo Pack



SIP-3				
for Ammo Pack only				
Dim	Min	Max		
Α	3.9	4.3		
a1	45° Typ			
a2	3° Typ			
В	2.8	3.2		
С	1.40	1.60		
D	0.35	0.41		
E	0.43	0.48		
F	0	0.2		
G	2.4	2.9		
N	0.63	0.84		
Р	1.55	-		
All Dimensions in mm				

#### Min/Max



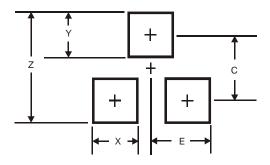
**Sensor location** 



# Suggested Pad Layout

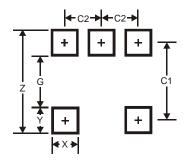
Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

#### (1) Package Type: SC59



Dimensions	Value (in mm)
Z	3.4
X	0.8
Y	1
С	2.4
E	1.35

#### (2) Package Type: SOT553



Dimensions	Value (in mm)
Z	2.2
G	1.2
Х	0.375
Y	0.5
C1	1.7
C2	0.5



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